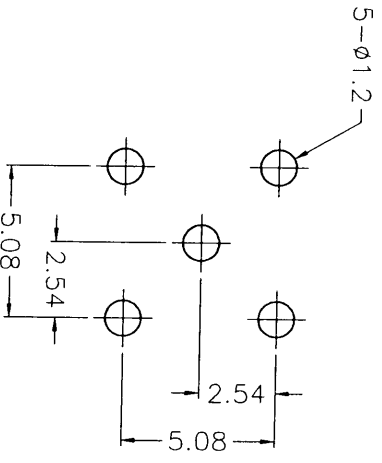
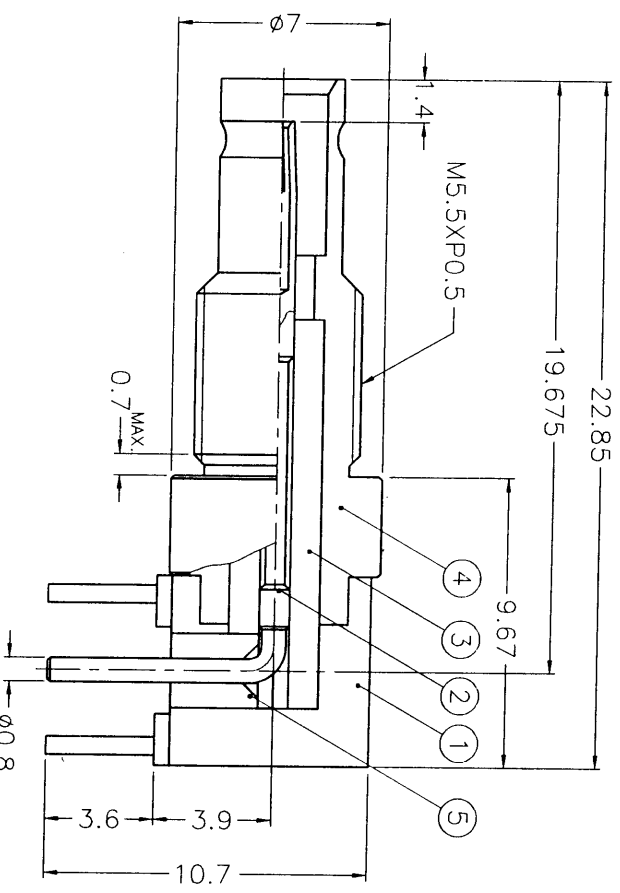
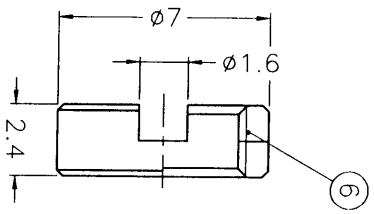


ISS	ZONE	DESCRIPTION \ PER REQUEST DATE
B	B-1	NO.6 WAS CHANGED \ RD-DM89051101C\05-11-00'

REVSIONS



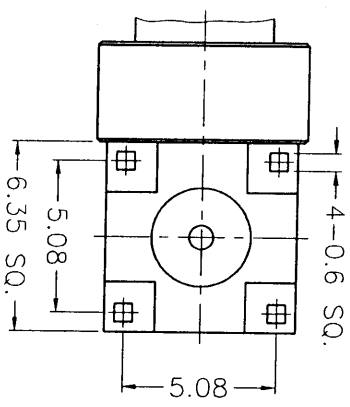
PCB MOUNTING HOLE
(印刷电路板架設孔)

- NOTES: FINISH (PLATING THICKNESS IN MICRO-INCHES)
1. BRASS PER 00-B-626
 2. GOLD PL. 3 MIN. THICK OVER NICKEL PL. 100 MIN. THICK OVER COPPER STRIKE
 3. NICKEL PL. 100 MIN. THICK OVER COPPER STRIKE
 4. BERYLLIUM COPPER PER 00-C-530
 5. GOLD PL. 30 MIN. THICK OVER NICKEL PL. 100 MIN. THICK OVER COPPER STRIKE
 6. TEFLON MIL-P-19468

NO.	DESCRIPTION	MATERIAL	FINISH	Q'TY	DRAWING NO.
1	HOUSING	NOTE 1	NOTE 2	1	1236252L1-1
2	CONTACT PIN	NOTE 4	NOTE 5	1	1236252L1-002-2-75
3	INSULATOR	NOTE 6	NATURAL	1	1236252L1-002-3
4	BODY	NOTE 1	NOTE 2	1	1236252L1-002-4
5	INSULATOR	NOTE 6	NATURAL	1	1236252L1-5T-50
6	SPANNER NUT	NOTE 1	NOTE 3	1	123-JACK-SN2

DIMENSIONS ARE IN MILLIMETERS
UNLESS OTHERWISE SPECIFIED
TOLERANCES

- 0.5-6 = ±0.2
- 6-30 = ±0.4
- 30-120 = ±0.6
- 120-315 = ±1
- 315-1000 = ±1.6
- 1000-2000 = ±2.4



Amphenol - Kai Jack
TAINAN TAIWAN

TITLE
1.0/2.3 R/A PCB JACK (75 Ohm)

DRAWING NO. KJ-1236252L1-002-N/3GT30G-75
FILE NO. F:\DWG\123\6252L1\002\75\N3GT30G

APPROVED
DATE 05-11-00'

CHECKED
DATE 05-11-00'

DRAWN
DATE 05-11-00'

1	2	3	4	5	6	7	8
SCALE	4/1	ISSUE	B				

8/351